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CONFIRMATION NO. 5582

Bib Data Sheet

SERIAL NUMBER	FILING OR 371(c) DATE 03/17/2004 RULE	CLASS 438	GROUP ART UNIT 2818	ATTORNEY DOCKET NO. GK0012-1C
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APPLICANTS

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** CONTINUING DATA *****

This application is a CON of 09/774,952 01/30/2001 PAT 6,762,078
 which is a DIV of 09/574,541 05/19/2000 PAT 6,395,578

** FOREIGN APPLICATIONS *****

REPUBLIC OF KOREA 1999-18244 05/20/1999
 REPUBLIC OF KOREA 1999-37925 09/07/1999
 REPUBLIC OF KOREA 1999-37928 09/07/1999

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

** 05/31/2004

Foreign Priority claimed	<input type="checkbox"/> yes <input type="checkbox"/> no	STATE OR COUNTRY KOREA, REPUBLIC OF	SHEETS DRAWING 16	TOTAL CLAIMS 7	INDEPENDENT CLAIMS 3
35 USC 119 (a-d) conditions met	<input type="checkbox"/> yes <input type="checkbox"/> no <input checked="" type="checkbox"/> Met after Allowance				
Verified and Acknowledged	Examiner's Signature _____ Initials _____				

ADDRESS

23513

TITLE

Stackable semiconductor package having semiconductor chip within central through hole of substrate

FILING FEE RECEIVED 770	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees
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